

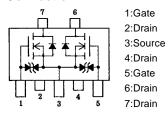
# **FP402**

N-Channel MOS Silicon FET Very High-Speed Switching Applicaitons

### **Features**

- · Low ON resistance.
- · Very high-speed switching.
- · Complex type with 2 low-voltage-drive N-channel MOSFETs facilitating high-density mounting.

#### **Electrical Connection**

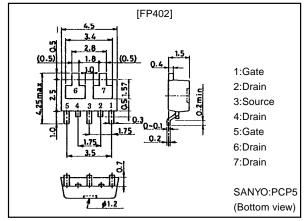


(Top view)

## **Package Dimensions**

unit:mm

2102A



## **Specifications**

### Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		20	V
Gate-to-Source Voltage	V <sub>GSS</sub>		±15	V
Drain Current (DC)	ΙD		1	Α
Drain Current (Pulse)	I <sub>DP</sub>	PW≤10μs, duty cycle ≤1%	4	Α
Allowable Power Dissipation	PD	Tc=25°C, 1 unit	2.0	W
	PD	Mounted on ceramic board (250mm <sup>2</sup> ×0.8mm) 1 unit	0.8	W
Total Power Dissipation	PT	Mounted on ceramic board (250mm <sup>2</sup> ×0.8mm)	1.1	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

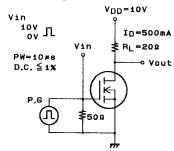
#### Electrical Characteristics at Ta=25°C

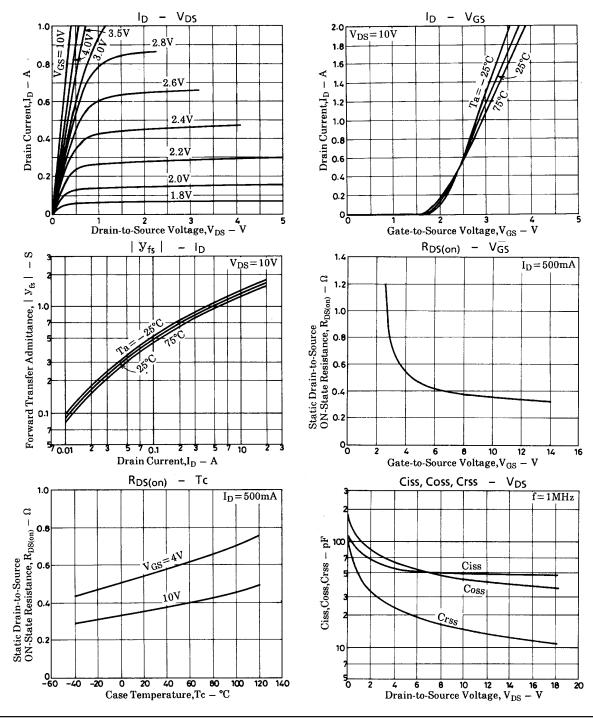
Parameter	Symbol	Conditons	Ratings			Unit
			min	typ	max	Offic
D-S Breakdown Voltage	V(BR)DSS	I <sub>D</sub> =1mA, V <sub>GS</sub> =0	20			V
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =20V, V <sub>GS</sub> =0			100	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0			±10	μΑ
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	0.8		2.0	V
Forward Transfer Admittance	Y <sub>fs</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =500mA	0.6	1.0		S
Static Drain-to-Source ON-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =500mA, V <sub>GS</sub> =10V		350	480	mΩ
	R <sub>DS(on)</sub>	I <sub>D</sub> =500mA, V <sub>GS</sub> =4V		550	750	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> =10V, f=1MHz		50		pF
Output Capacitance	Coss	V <sub>DS</sub> =10V, f=1MHz		45		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =10V, f=1MHz		15		pF
Turn-ON Delay Time	t <sub>d(on)</sub>	See specified Test Circuit		8		ns
Rise Time	t <sub>r</sub>	See specified Test Circuit		10		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit		30		ns
Fall Time	t <sub>f</sub>	See specified Test Circuit		20		ns
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1A, V <sub>GS</sub> =0		1.0		V

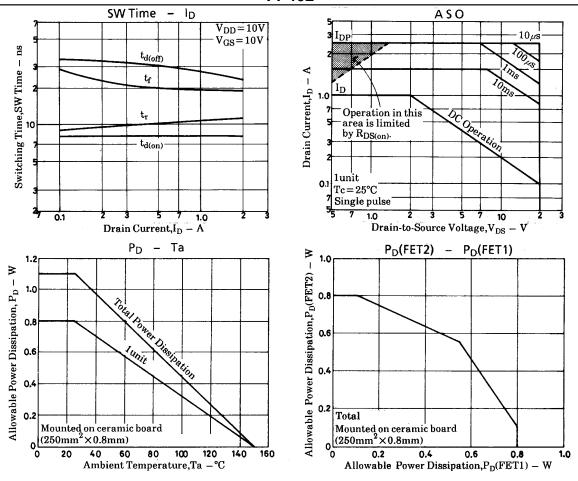
Marking:402

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### **Switching Time Test Circuit**







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